

**OPA241**  
**OPA2241**  
**OPA4241**  
**OPA251**  
**OPA2251**  
**OPA4251**

## Single-Supply, *Micro*POWER OPERATIONAL AMPLIFIERS

**OPA241 Family** optimized for +5V supply.

**OPA251 Family** optimized for  $\pm 15\text{V}$  supply.

### FEATURES

- **MicroPOWER:**  $I_Q = 25\mu\text{A}$
- **SINGLE-SUPPLY OPERATION**
- **RAIL-TO-RAIL OUTPUT** (within 50mV)
- **WIDE SUPPLY RANGE**  
Single Supply: +2.7V to +36V  
Dual Supply:  $\pm 1.35\text{V}$  to  $\pm 18\text{V}$
- **LOW OFFSET VOLTAGE:**  $\pm 250\mu\text{V}$  max
- **HIGH COMMON-MODE REJECTION:** 124dB
- **HIGH OPEN-LOOP GAIN:** 128dB
- **SINGLE, DUAL, AND QUAD**

### APPLICATIONS

- **BATTERY OPERATED INSTRUMENTS**
- **PORTABLE DEVICES**
- **MEDICAL INSTRUMENTS**
- **TEST EQUIPMENT**

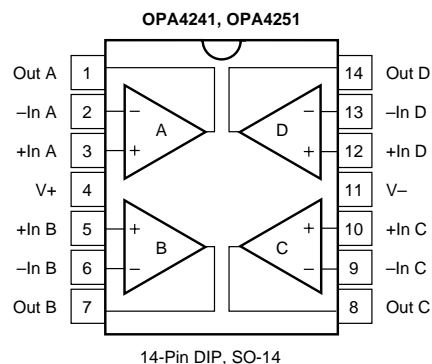
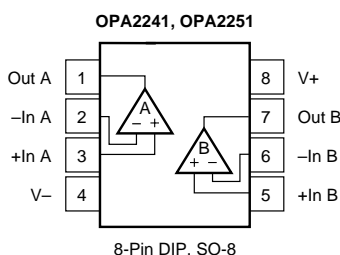
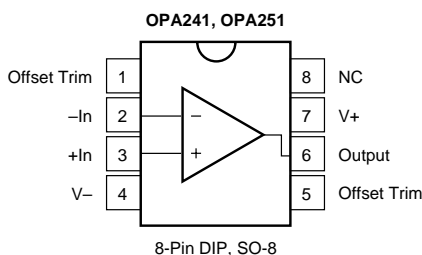
### DESCRIPTION

The OPA241 series and OPA251 series are specifically designed for battery powered, portable applications. In addition to very low power consumption ( $25\mu\text{A}$ ), these amplifiers feature low offset voltage, rail-to-rail output swing, high common-mode rejection, and high open-loop gain.

The OPA241 series is optimized for operation at low power supply voltage while the OPA251 series is optimized for high power supplies. Both can operate from either single (+2.7V to +36V) or dual supplies ( $\pm 1.35\text{V}$  to  $\pm 18\text{V}$ ). The input common-mode voltage range extends 200mV below the negative supply—ideal for single-supply applications.

They are unity-gain stable and can drive large capacitive loads. Special design considerations assure that these products are easy to use. High performance is maintained as the amplifiers swing to their specified limits. Because the initial offset voltage ( $\pm 250\mu\text{V}$  max) is so low, user adjustment is usually not required. However, external trim pins are provided for special applications (single versions only).

The OPA241 and OPA251 (single versions) are available in standard 8-pin DIP and SO-8 surface-mount packages. The OPA2241 and OPA2251 (dual versions) come in 8-pin DIP and SO-8 surface-mount packages. The OPA4241 and OPA4251 (quad versions) are available in 14-pin DIP and SO-14 surface-mount packages. All are fully specified from  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$  and operate from  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$ .



# SPECIFICATIONS: $V_S = 2.7V$ to $5V$

At  $T_A = +25^\circ C$ ,  $R_L = 100k\Omega$  connected to  $V_S/2$ , unless otherwise noted.

**Boldface** limits apply over the specified temperature range,  $T_A = -40^\circ C$  to  $+85^\circ C$ .

PARAMETER	CONDITION	OPA241UA, PA OPA2241UA, PA OPA4241UA, PA			OPA251UA, PA OPA2251UA, PA OPA4251UA, PA			UNITS
		MIN	TYP <sup>(1)</sup>	MAX	MIN	TYP <sup>(1)</sup>	MAX	
<b>OFFSET VOLTAGE</b> Input Offset Voltage $V_{OS}$ $T_A = -40^\circ C$ to $+85^\circ C$ vs Temperature $dV_{OS}/dT$ vs Power Supply PSRR $T_A = -40^\circ C$ to $+85^\circ C$ Channel Separation (dual, quad)	$T_A = -40^\circ C$ to $+85^\circ C$ $V_S = 2.7V$ to $36V$ $V_S = 2.7V$ to $36V$		$\pm 50$ <b><math>\pm 100</math></b> $\pm 0.4$ 3 0.3	$\pm 250$ <b><math>\pm 400</math></b> 30 <b>30</b>		$\pm 100$ <b><math>\pm 130</math></b> $\pm 0.6$ * *	* *	$\mu V$ $\mu V$ $\mu V/^\circ C$ $\mu V/V$ $\mu V/V$
<b>INPUT BIAS CURRENT</b> Input Bias Current <sup>(2)</sup> $I_B$ $T_A = -40^\circ C$ to $+85^\circ C$ Input Offset Current $I_{OS}$ $T_A = -40^\circ C$ to $+85^\circ C$			-4 $\pm 0.1$	-20 <b>-25</b> $\pm 2$ <b><math>\pm 2</math></b>		* *		nA nA nA nA
<b>NOISE</b> Input Voltage Noise, $f = 0.1Hz$ to $10Hz$ Input Voltage Noise Density, $f = 1kHz$ $e_n$ Current Noise Density, $f = 1kHz$ $i_n$			1 45 40			* * *		$\mu Vp-p$ $nV/\sqrt{Hz}$ $fA/\sqrt{Hz}$
<b>INPUT VOLTAGE RANGE</b> Common-Mode Voltage Range $V_{CM}$ Common-Mode Rejection Ratio CMRR $T_A = -40^\circ C$ to $+85^\circ C$	$V_{CM} = -0.2V$ to $(V+) - 0.8V$ $V_{CM} = 0V$ to $(V+) - 0.8V$	-0.2 80 <b>80</b>	106	$(V+) - 0.8$		*		V dB dB
<b>INPUT IMPEDANCE</b> Differential Common-Mode			$10^7 \parallel 2$ $10^9 \parallel 4$			* *		$\Omega \parallel pF$ $\Omega \parallel pF$
<b>OPEN-LOOP GAIN</b> Open-Loop Voltage Gain $A_{OL}$ $T_A = -40^\circ C$ to $+85^\circ C$ $T_A = -40^\circ C$ to $+85^\circ C$	$R_L = 100k\Omega$ , $V_O = (V-) + 100mV$ to $(V+) - 100mV$ $R_L = 100k\Omega$ , $V_O = (V-) + 100mV$ to $(V+) - 100mV$ $R_L = 10k\Omega$ , $V_O = (V-) + 200mV$ to $(V+) - 200mV$ $R_L = 10k\Omega$ , $V_O = (V-) + 200mV$ to $(V+) - 200mV$	100 <b>100</b> 100 <b>100</b>	120 120			* *		dB dB dB dB
<b>FREQUENCY RESPONSE</b> Gain-Bandwidth Product GBW Slew Rate SR Overload Recovery Time	$V_S = 5V$ , $G = 1$ $V_{IN} \cdot G = V_S$		35 0.01 60			* * *		kHz V/ $\mu s$ $\mu s$
<b>OUTPUT</b> Voltage Output Swing from Rail <sup>(3)</sup> $V_O$ $T_A = -40^\circ C$ to $+85^\circ C$ $T_A = -40^\circ C$ to $+85^\circ C$ Short-Circuit Current $I_{SC}$ Single Versions Dual, Quad Versions Capacitive Load Drive $C_{LOAD}$	$R_L = 100k\Omega$ to $V_S/2$ , $A_{OL} \geq 70dB$ $R_L = 100k\Omega$ to $V_S/2$ , $A_{OL} \geq 100dB$ $R_L = 100k\Omega$ to $V_S/2$ , $A_{OL} \geq 100dB$ $R_L = 10k\Omega$ to $V_S/2$ , $A_{OL} \geq 100dB$ $R_L = 10k\Omega$ to $V_S/2$ , $A_{OL} \geq 100dB$		50 75 100	100 <b>100</b> 200 <b>200</b>		* * *		mV mV mV mV
			-24/+4 -30/+4			* * *		mA mA
			See Typical Curve					
<b>POWER SUPPLY</b> Specified Voltage Range $V_S$ Operating Voltage Range Quiescent Current (per amplifier) $I_Q$ $T_A = -40^\circ C$ to $+85^\circ C$	$T_A = -40^\circ C$ to $+85^\circ C$ $I_O = 0$ $I_O = 0$	<b>+2.7</b>	+2.7 to +5 $\pm 25$	<b>+36</b> $\pm 30$ <b><math>\pm 36</math></b>	*	* *	*	V V $\mu A$ $\mu A$
<b>TEMPERATURE RANGE</b> Specified Range Operating Range Storage Range Thermal Resistance $\theta_{JA}$ 8-Pin DIP SO-8 Surface Mount 14-Pin DIP SO-14 Surface Mount		-40 -55 -55		+85 +125 +125	* * *		* * *	$^\circ C$ $^\circ C$ $^\circ C$ $^\circ C/W$ $^\circ C/W$ $^\circ C/W$ $^\circ C/W$

\* Specifications the same as OPA241UA, PA.

NOTES: (1)  $V_S = +5V$ . (2) The negative sign indicates input bias current flows out of the input terminals. (3) Output voltage swings are measured between the output and power supply rails.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.

# SPECIFICATIONS: $V_S = \pm 15V$

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\text{k}\Omega$  connected to ground, unless otherwise noted.

**Boldface** limits apply over the specified temperature range,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

PARAMETER	CONDITION	OPA241UA, PA OPA2241UA, PA OPA4241UA, PA			OPA251UA, PA OPA2251UA, PA OPA4251UA, PA			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>OFFSET VOLTAGE</b> Input Offset Voltage $V_{OS}$ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ vs Temperature $dV_{OS}/dT$ vs Power Supply PSRR $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ Channel Separation (dual, quad)	$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ $V_S = \pm 1.35V$ to $\pm 18V$ $V_S = \pm 1.35V$ to $\pm 18V$		$\pm 100$ <b><math>\pm 150</math></b> $\pm 0.6$ * *	* * *		$\pm 50$ <b><math>\pm 100</math></b> $\pm 0.5$ 3 0.3	$\pm 250$ <b><math>\pm 300</math></b> 30 <b>30</b>	$\mu\text{V}$ $\mu\text{V}$ $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/V$ $\mu\text{V}/V$
<b>INPUT BIAS CURRENT</b> Input Bias Current <sup>(1)</sup> $I_B$ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ Input Offset Current $I_{OS}$ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$			* *			-4 $\pm 0.1$	-20 $\pm 2$ $\pm 2$	nA nA nA
<b>NOISE</b> Input Voltage Noise, $f = 0.1\text{Hz}$ to $10\text{Hz}$ Input Voltage Noise Density, $f = 1\text{kHz}$ $e_n$ Current Noise Density, $f = 1\text{kHz}$ $i_n$			* * *			1 45 40		$\mu\text{Vp-p}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{fA}/\sqrt{\text{Hz}}$
<b>INPUT VOLTAGE RANGE</b> Common-Mode Voltage Range $V_{CM}$ Common-Mode Rejection Ratio CMRR $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	$V_{CM} = -15.2V$ to $14.2V$ $V_{CM} = -15V$ to $14.2V$		*		(V-) -0.2 100 <b>100</b>	124	(V+) -0.8	V dB dB
<b>INPUT IMPEDANCE</b> Differential Common-Mode			* *			$10^7 \parallel 2$ $10^9 \parallel 4$		$\Omega \parallel \text{pF}$ $\Omega \parallel \text{pF}$
<b>OPEN-LOOP GAIN</b> Open-Loop Voltage Gain $A_{OL}$ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$  $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	$R_L = 100\text{k}\Omega$ , $V_O = -14.75V$ to $+14.75V$ $R_L = 100\text{k}\Omega$ , $V_O = -14.75V$ to $+14.75V$ $R_L = 20\text{k}\Omega$ , $V_O = -14.7V$ to $+14.7V$ $R_L = 20\text{k}\Omega$ , $V_O = -14.7V$ to $+14.7V$		* * *		100 <b>100</b> 100 <b>100</b>	128  128		dB dB dB dB
<b>FREQUENCY RESPONSE</b> Gain-Bandwidth Product GBW Slew Rate SR Overload Recovery Time	$G = 1$ $V_{IN} \cdot G = V_S$		* * *			35 0.01 60		kHz V/ $\mu\text{s}$ $\mu\text{s}$
<b>OUTPUT</b> Voltage Output Swing from Rail <sup>(2)</sup> $V_O$  $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ Short-Circuit Current $I_{SC}$ Single Versions Dual Versions Capacitive Load Drive $C_{LOAD}$	$R_L = 100\text{k}\Omega$ , $A_{OL} \geq 70\text{dB}$ $R_L = 100\text{k}\Omega$ , $A_{OL} \geq 100\text{dB}$ $R_L = 100\text{k}\Omega$ , $A_{OL} \geq 100\text{dB}$ $R_L = 20\text{k}\Omega$ , $A_{OL} \geq 100\text{dB}$ $R_L = 20\text{k}\Omega$ , $A_{OL} \geq 100\text{dB}$		* * * * * *			50 75  100  -21/+4 -50/+4	250 <b>250</b> 300 <b>300</b>	mV mV mV mV mA mA
<b>POWER SUPPLY</b> Specified Voltage Range $V_S$ Operating Voltage Range Quiescent Current (per amplifier) $I_Q$ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ $I_O = 0$ $I_O = 0$	*	* *	*	$\pm 1.35$	$\pm 15$ $\pm 27$	$\pm 18$ $\pm 38$ <b><math>\pm 45</math></b>	V V $\mu\text{A}$ $\mu\text{A}$
<b>TEMPERATURE RANGE</b> Specified Range Operating Range Storage Range Thermal Resistance $\theta_{JA}$ 8-Pin DIP SO-8 Surface Mount 14-Pin DIP SO-14 Surface Mount		* * *		* * *	-40 -55 -55		+85 +125 +125	$^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}$ $^\circ\text{C}/W$ $^\circ\text{C}/W$ $^\circ\text{C}/W$ $^\circ\text{C}/W$

\* Specifications the same as OPA251UA, PA.

NOTES: (1) The negative sign indicates input bias current flows out of the input terminals. (2) Output voltage swings are measured between the output and power supply rails.

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Supply Voltage, V+ to V- .....	36V
Input Voltage <sup>(2)</sup> .....	(V-) -0.5V to (V+) +0.5V
Output Short Circuit to Ground <sup>(3)</sup> .....	Continuous
Operating Temperature .....	-55°C to +125°C
Storage Temperature .....	-55°C to +125°C
Junction Temperature .....	150°C
Lead Temperature (soldering, 10s) .....	300°C

NOTES: (1) Stresses above these ratings may cause permanent damage.

(2) Input terminals are diode-clamped to the power supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 5mA or less. (3) One amplifier per package.



## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION

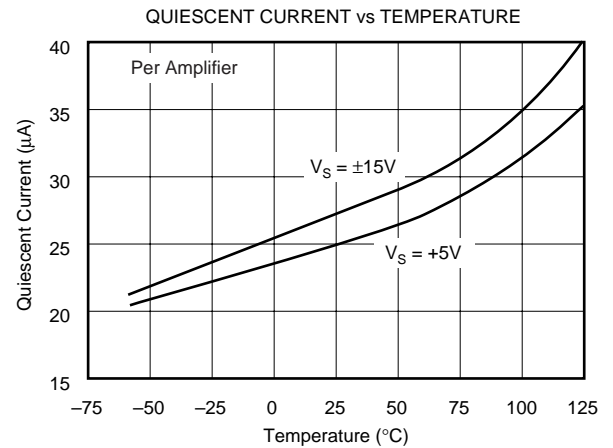
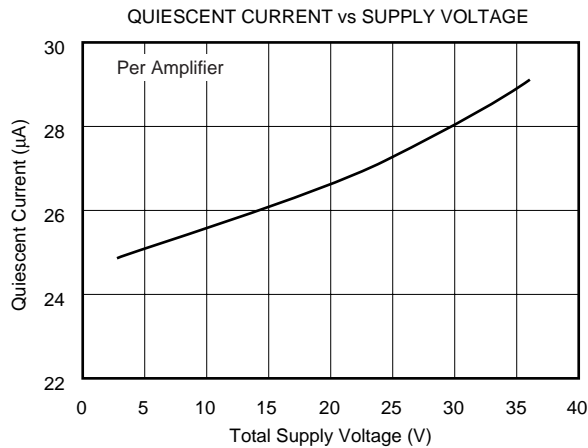
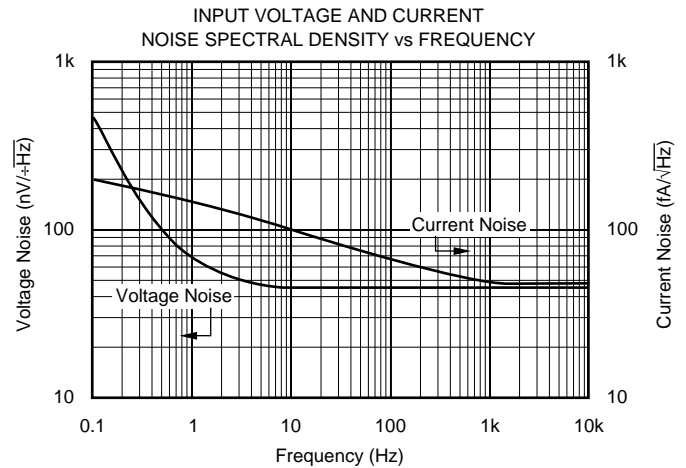
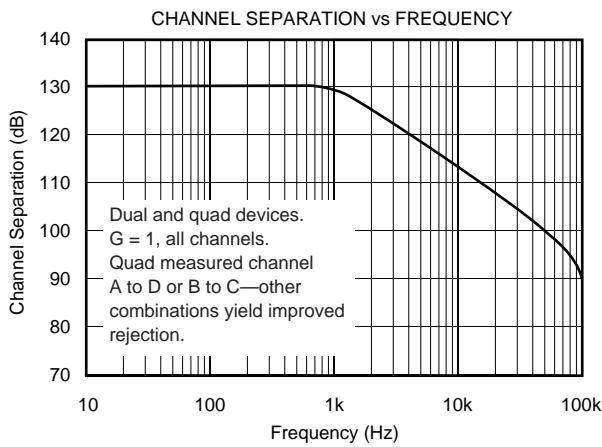
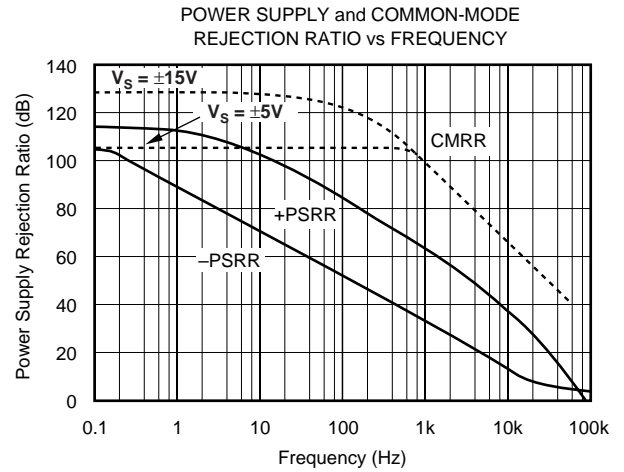
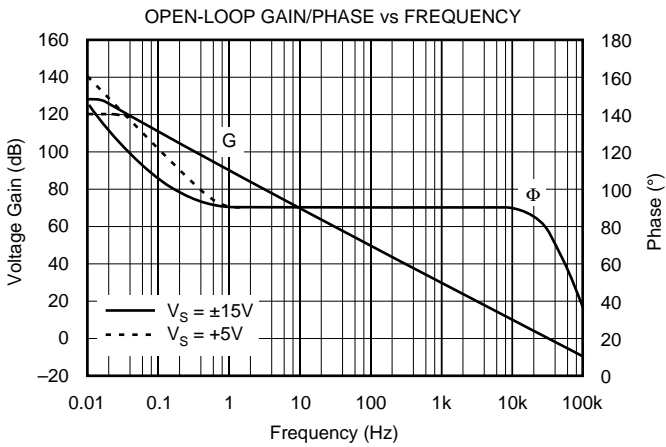
PRODUCT	SPECIFIED VOLTAGE	OPERATING VOLTAGE RANGE	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>	SPECIFICATION TEMPERATURE RANGE
<b>OPA241 SERIES</b>					
<b>Single</b> OPA241PA OPA241UA	2.7V to 5V 2.7V to 5V	2.7V to 36V 2.7V to 36V	8-Pin DIP SO-8 Surface Mount	006 182	-40°C to +85°C -40°C to +85°C
<b>Dual</b> OPA2241PA OPA2241UA	2.7V to 5V 2.7V to 5V	2.7V to 36V 2.7V to 36V	8-Pin DIP SO-8 Surface Mount	006 182	-40°C to +85°C -40°C to +85°C
<b>Quad</b> OPA4241PA OPA4241UA	2.7V to 5V 2.7V to 5V	2.7V to 36V 2.7V to 36V	14-Pin DIP SO-14 Surface Mount	010 235	-40°C to +85°C -40°C to +85°C
<b>OPA251 SERIES</b>					
<b>Single</b> OPA251PA OPA251UA	±15V ±15V	2.7V to 36V 2.7V to 36V	8-Pin DIP SO-8 Surface Mount	006 182	-40°C to +85°C -40°C to +85°C
<b>Dual</b> OPA2251PA OPA2251UA	±15V ±15V	2.7V to 36V 2.7V to 36V	8-Pin DIP SO-8 Surface Mount	006 182	-40°C to +85°C -40°C to +85°C
<b>Quad</b> OPA4251PA OPA4251UA	±15V ±15V	2.7V to 36V 2.7V to 36V	14-Pin DIP SO-14 Surface Mount	010 235	-40°C to +85°C -40°C to +85°C

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

# TYPICAL PERFORMANCE CURVES

At  $T_A = +25^\circ\text{C}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$  (ground for  $V_S = \pm 15\text{V}$ ), unless otherwise noted.

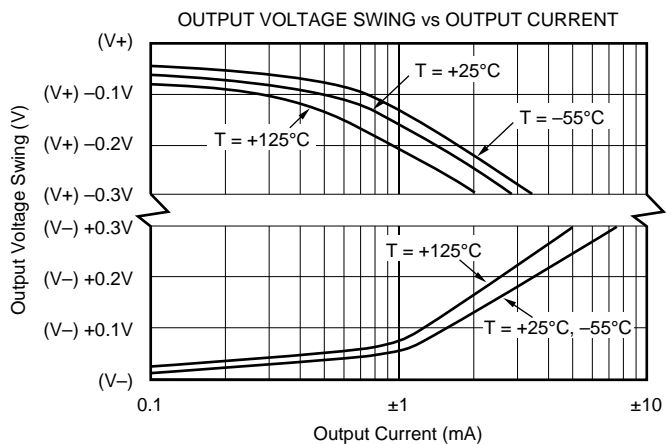
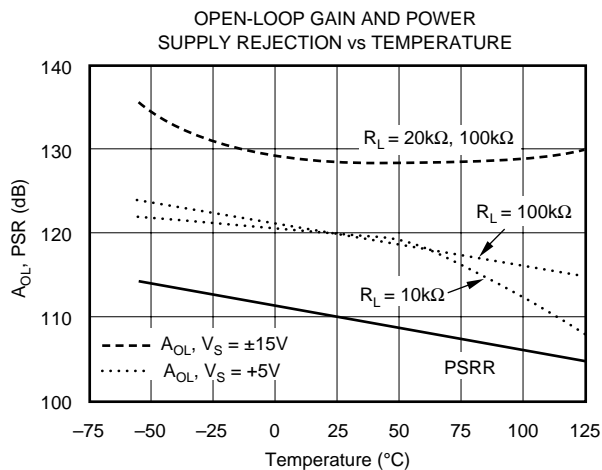
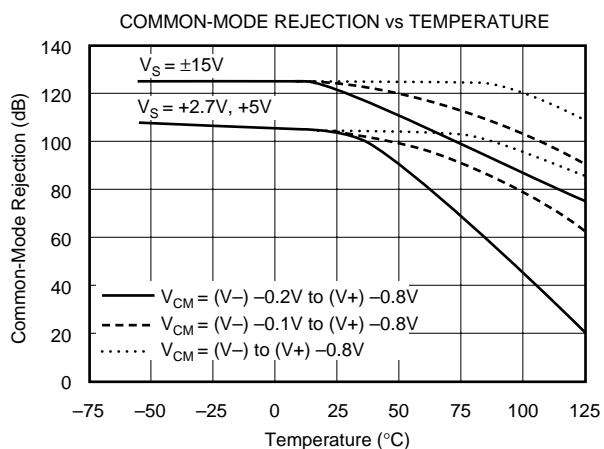
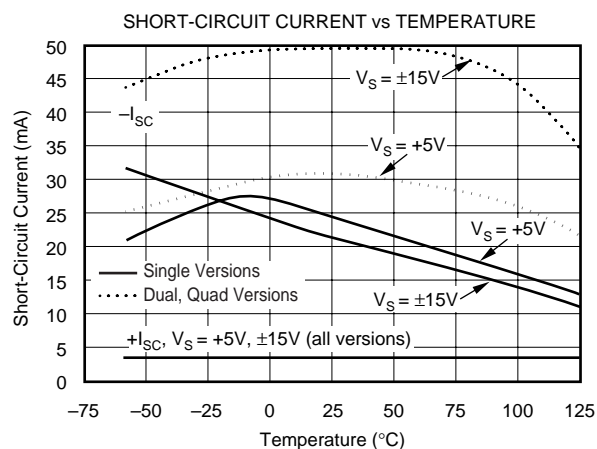
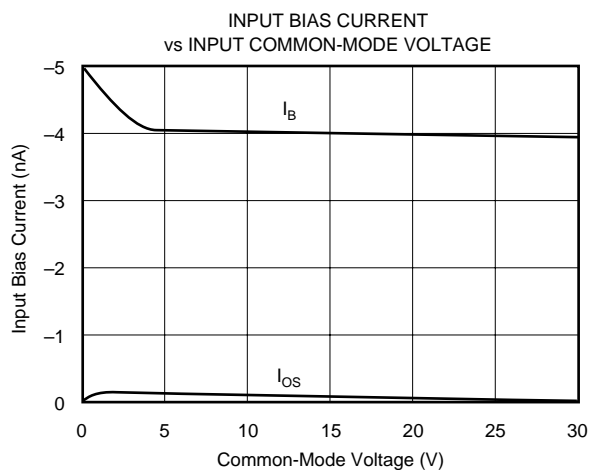
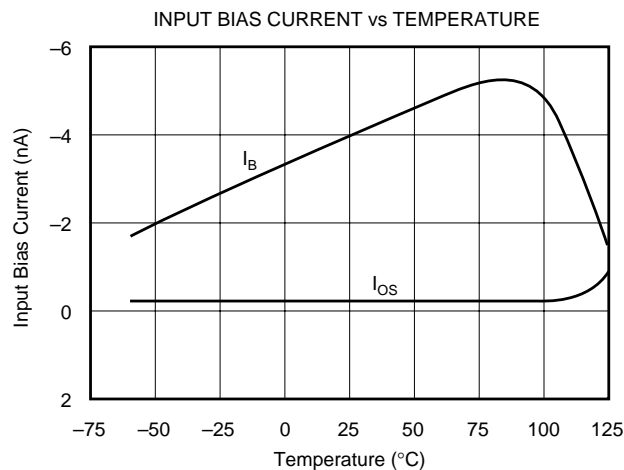
Curves apply to OPA241 and OPA251 unless specified.



# TYPICAL PERFORMANCE CURVES (CONT)

At  $T_A = +25^\circ\text{C}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$  (ground for  $V_S = \pm 15\text{V}$ ), unless otherwise noted.

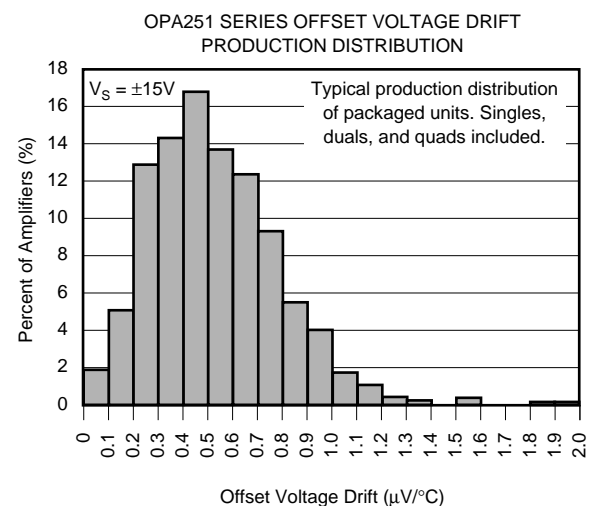
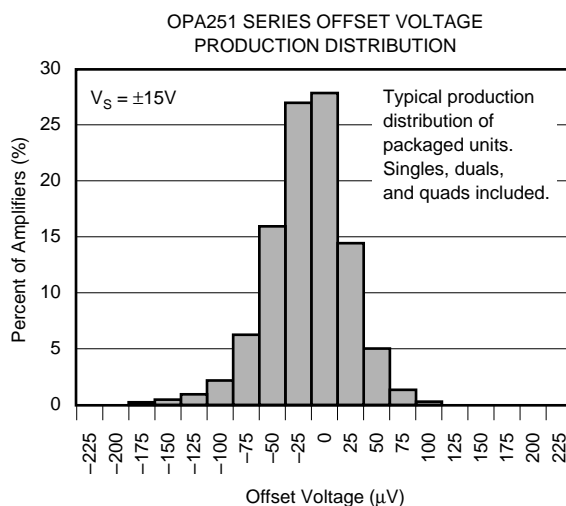
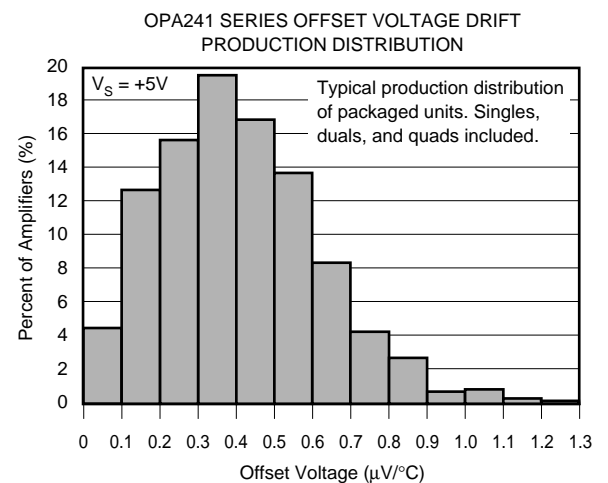
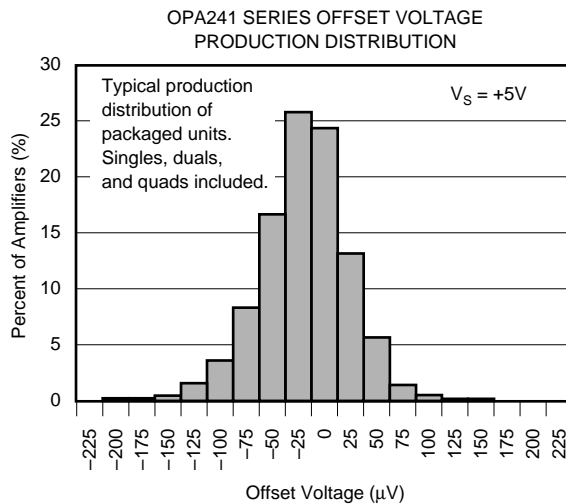
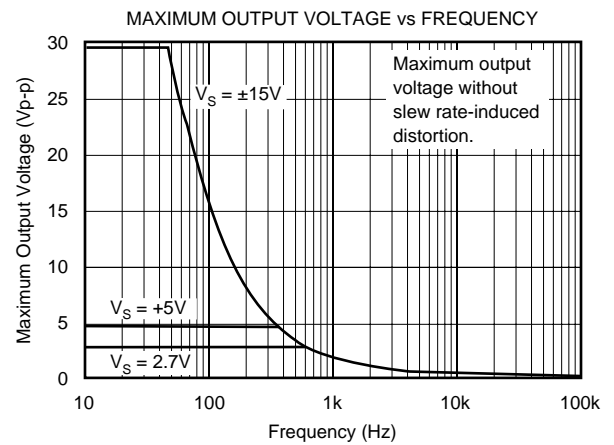
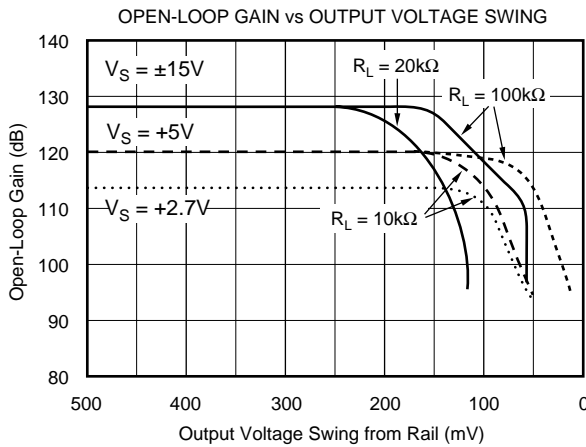
Curves apply to OPA241 and OPA251 unless specified.



# TYPICAL PERFORMANCE CURVES (CONT)

At  $T_A = +25^\circ\text{C}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$  (ground for  $V_S = \pm 15\text{V}$ ), unless otherwise noted.

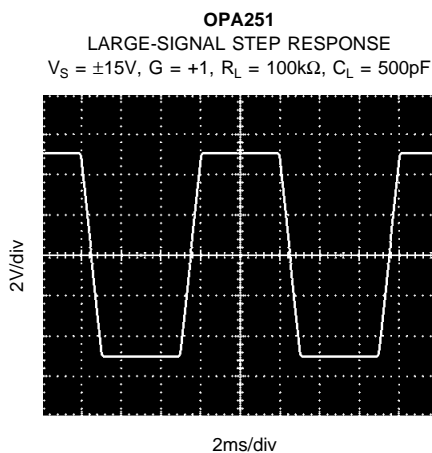
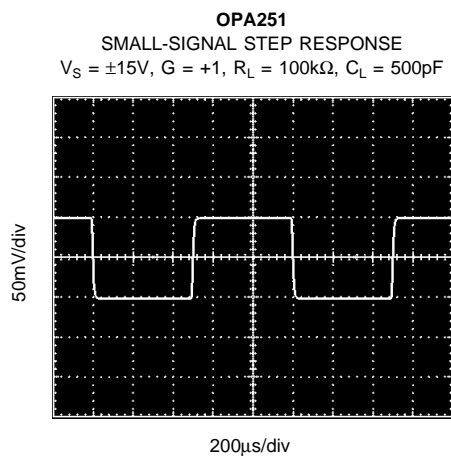
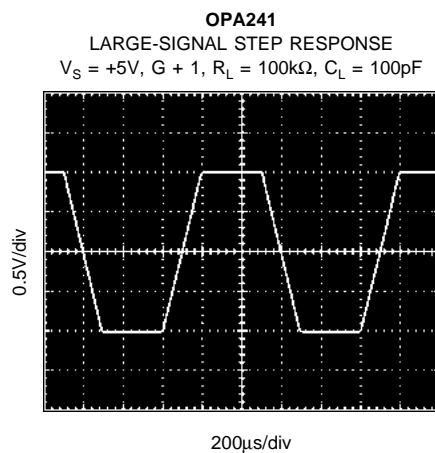
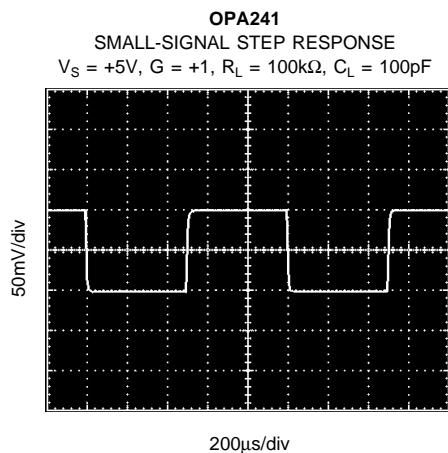
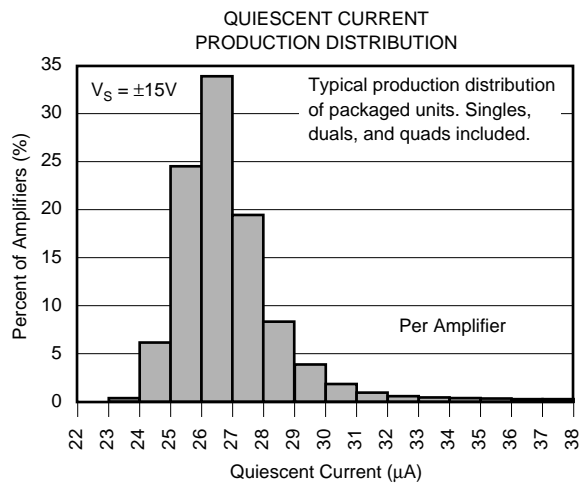
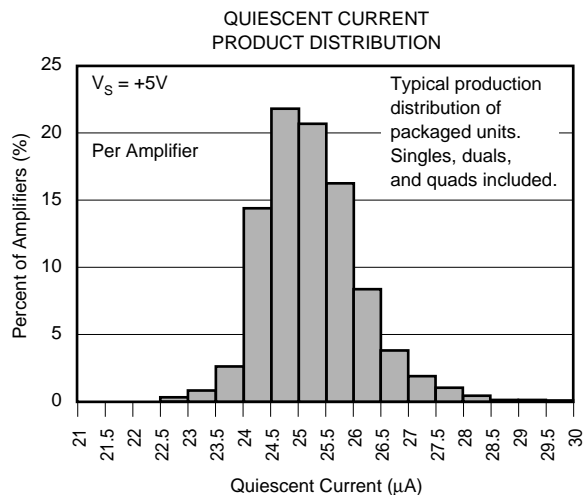
Curves apply to OPA241 and OPA251 unless specified.



# TYPICAL PERFORMANCE CURVES (CONT)

At  $T_A = +25^\circ\text{C}$ , and  $R_L = 100\text{k}\Omega$  connected to  $V_S/2$  (ground for  $V_S \pm 15\text{V}$ ), unless otherwise noted.

Curves apply to OPA241 and OPA251 unless specified.



# APPLICATIONS INFORMATION

The OPA241 and OPA251 series are unity-gain stable and suitable for a wide range of general purpose applications. Power supply pins should be bypassed with 0.01 $\mu$ F ceramic capacitors.

## OPERATING VOLTAGE

The OPA241 series is laser-trimmed for low offset voltage and drift at low supply voltage ( $V_S = +5V$ ). The OPA251 series is trimmed for  $\pm 15V$  operation. Both products operate over the full voltage range (+2.7V to +36V or  $\pm 1.35V$  to  $\pm 18V$ ) with some compromises in offset voltage and drift performance. However, all other parameters have similar performance. Key parameters are guaranteed over the specified temperature range,  $-40^\circ C$  to  $+85^\circ C$ . Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage or temperature are shown in typical performance curves.

## OFFSET VOLTAGE TRIM

As mentioned previously, offset voltage of the OPA241 series is laser-trimmed at +5V. The OPA251 series is trimmed at  $\pm 15V$ . Because the initial offset is so low, user adjustment is usually not required. However, the OPA241 and OPA251 (single op amp versions) provide offset voltage trim connections on pins 1 and 5. Offset voltage can be adjusted by connecting a potentiometer as shown in Figure 1. This adjustment should be used only to null the offset of the op amp, not to adjust system offset or offset produced by the signal source. Nulling offset could degrade the offset drift behavior of the op amp. While it is not possible to predict the exact change in drift, the effect is usually small.

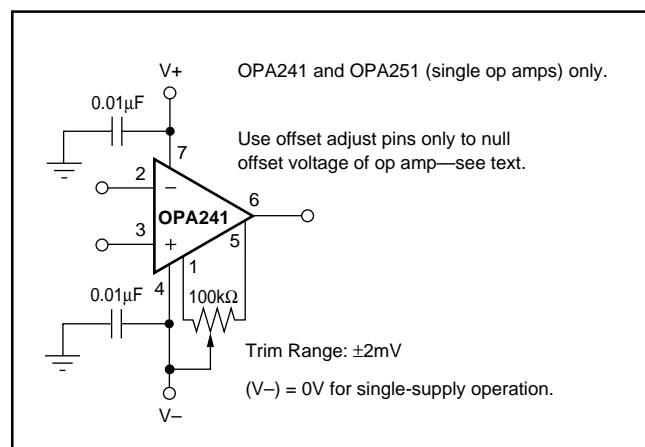


FIGURE 1. OPA241 and OPA251 Offset Voltage Trim Circuit.

## CAPACITIVE LOAD AND STABILITY

The OPA241 series and OPA251 series can drive a wide range of capacitive loads. However, all op amps under certain conditions may be unstable. Op amp configuration, gain, and load value are just a few of the factors to consider when determining stability.

Figures 2 and 3 show the regions where the OPA241 series and OPA251 series have the potential for instability. As shown, the unity gain configuration with low supplies is the most susceptible to the effects of capacitive load. With  $V_S = +5V$ ,  $G = +1$ , and  $I_{OUT} = 0$ , operation remains stable with load capacitance up to approximately 200pF. Increasing supply voltage, output current, and/or gain significantly improves capacitive load drive. For example, increasing the supplies to  $\pm 15V$  and gain to 10 allows approximately 2700pF to be driven.

One method of improving capacitive load drive in the unity gain configuration is to insert a resistor inside the feedback loop as shown in Figure 4. This reduces ringing with large capacitive loads while maintaining dc accuracy. For example, with  $V_S = \pm 1.35V$  and  $R_S = 5k\Omega$ , the OPA241 series and OPA251 series perform well with capacitive loads in excess of 1000pF. Without the series resistor, capacitive load drive is typically 200pF for these conditions. However, this method will result in a slight reduction of output voltage swing.

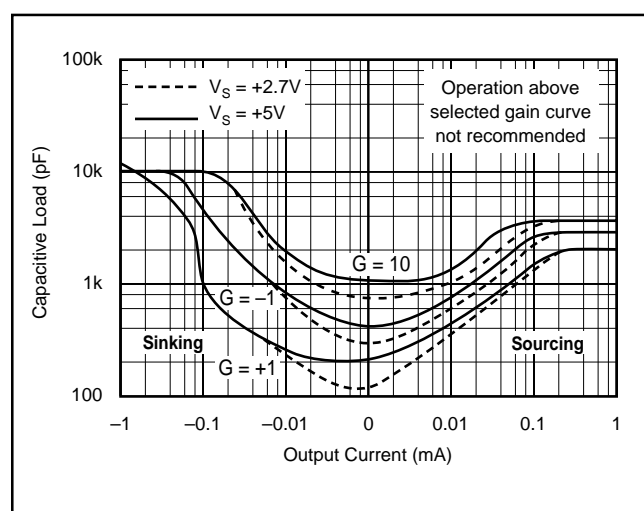


FIGURE 2. Stability—Capacitive Load versus Output Current for Low Supply Voltage.

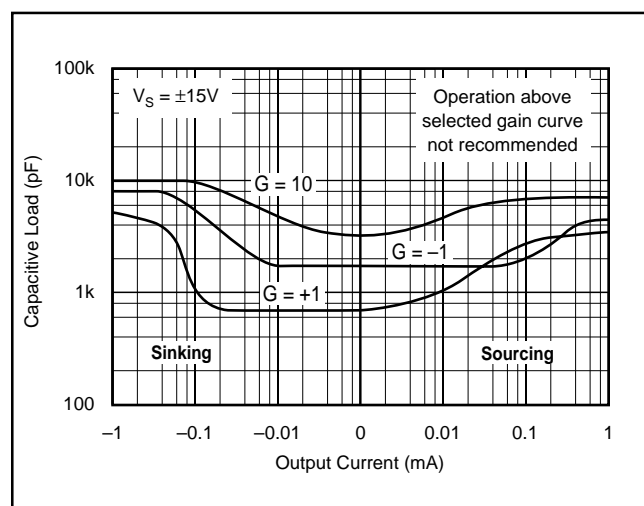


FIGURE 3. Stability—Capacitive Load versus Output Current for  $\pm 15V$  Supplies.

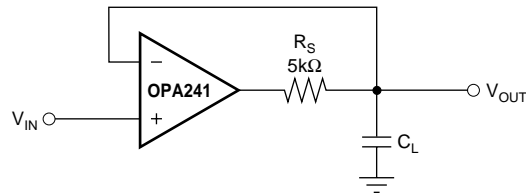
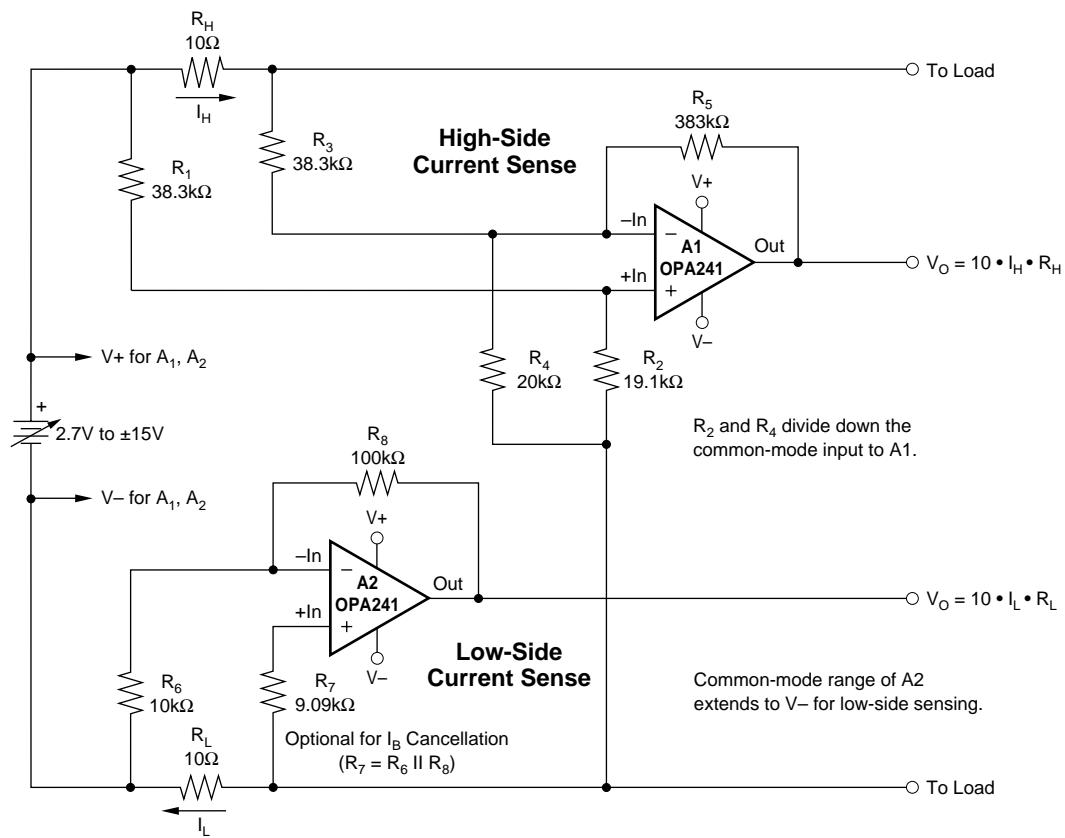


FIGURE 4. Series Resistor in Unity Gain Configuration Improves Capacitive Load Drive.



NOTE: Low and high-side sensing circuits can be used independently.

FIGURE 5. Low and High-Side Battery Current Sensing.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
OPA2241PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2241PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2241UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2241UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2241UA/2K5G4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2241UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2251PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2251PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2251UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2251UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2251UA/2K5G4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2251UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA241PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA241PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA241UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA241UA/2K5	ACTIVE	SOIC	D	8	1	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA241UA/2K5E4	PREVIEW	SOIC	D	8		TBD	Call TI	Call TI
OPA241UA/2K5G4	ACTIVE	SOIC	D	8	1	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA241UAE4	PREVIEW	SOIC	D	8		TBD	Call TI	Call TI
OPA241UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA251PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA251PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA251UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA251UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA251UA/2K5G4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA251UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
no Sb/Br)								
OPA4241PA	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4241PAG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4241UA	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4241UA/2K5	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4241UA/2K5G4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4241UAG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4251PA	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4251PAG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4251UA	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4251UA/2K5	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4251UA/2K5G4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4251UAG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

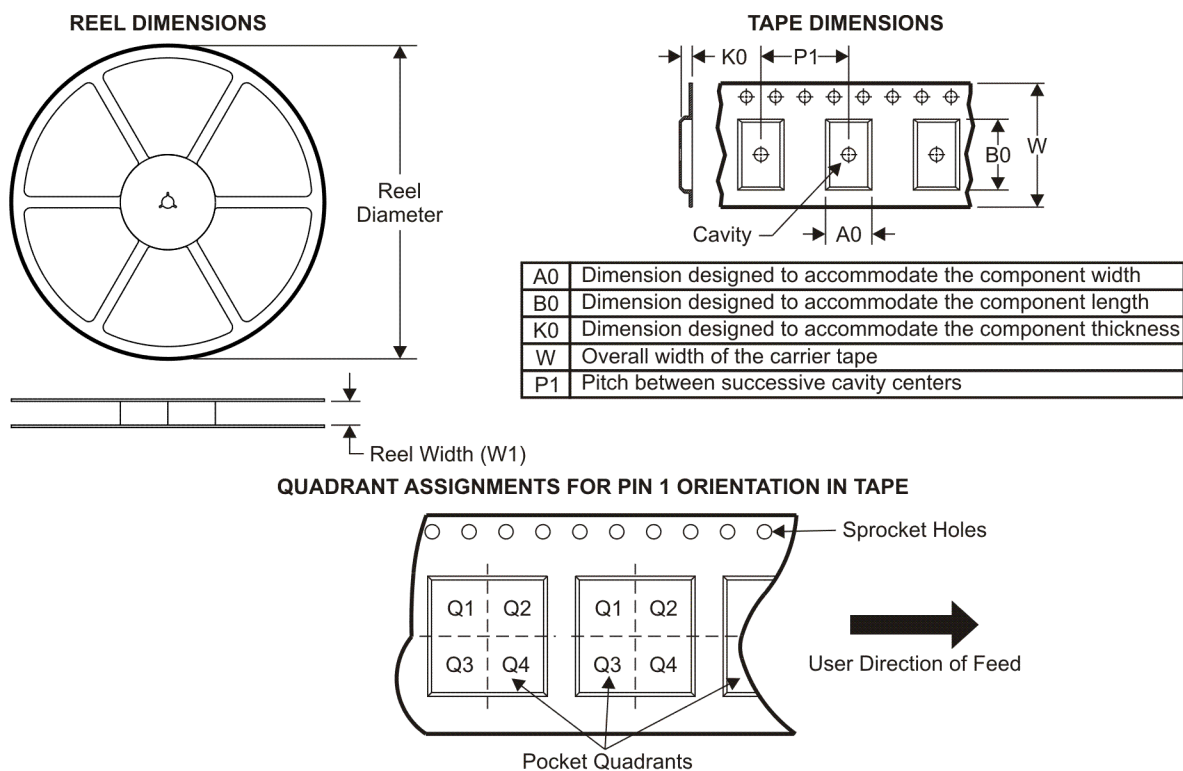
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

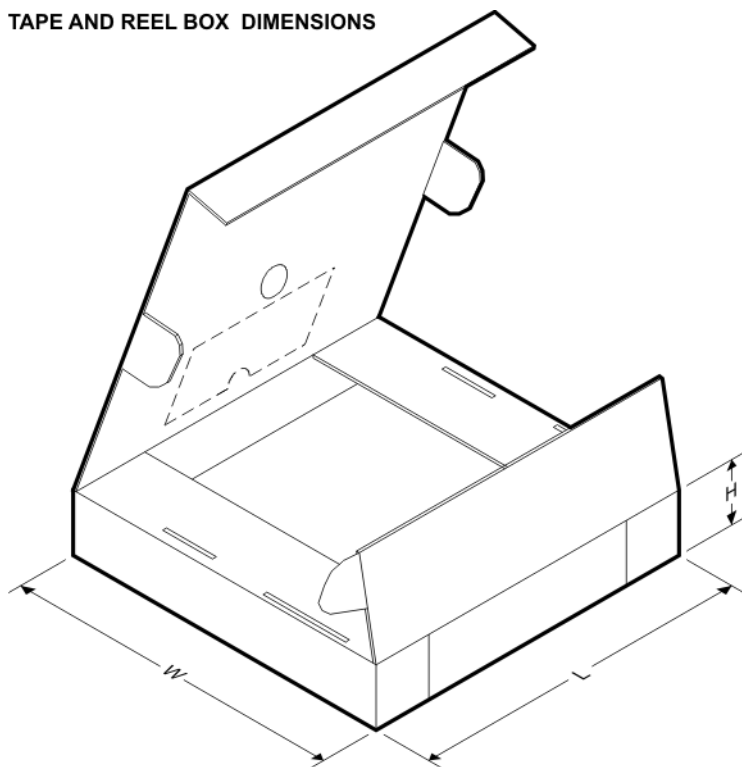
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA2241UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA2251UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA241UA/2K5	SOIC	D	8	1	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA251UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4241UA/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
OPA4251UA/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA2241UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA2251UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA241UA/2K5	SOIC	D	8	1	346.0	346.0	29.0
OPA251UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA4241UA/2K5	SOIC	D	14	2500	346.0	346.0	33.0
OPA4251UA/2K5	SOIC	D	14	2500	346.0	346.0	33.0

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>	Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>	Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Energy	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>	Space, Avionics & Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>	Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless-apps">www.ti.com/wireless-apps</a>